

PSE Technology Corporation

SPECIFICATION FOR APPROVAL

CUSTOMER 32.768 KHz NOMINAL FREQUENCY TYPE G5 SMD CRYSTAL PRODUCT TYPE G53270004 SPEC. NO. (P/N) **CUSTOMER P/N** Mar.10,2014 **ISSUE DATE** G **VERSION**

APPROVED	PREPARED	QA
Brenda	Clane	Bedryni
APPROVED BY	AVL Status	
Please return one copy		

PSE Technology Corporation

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*RoHS Exception

*HF-Halogen Free

*REACH Compliant



*** A company of 12 PERICOM Semiconductor Corporation ***

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VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
Α	Sep.28,2009			Initial Release	
В	May.5,2010			Change Marking	
С	Jul.1,2010			Change ESR from $60 \text{K}\Omega$ to $65 \text{K}\Omega$	
D	Sep.21,2010			New Logo & Changed Marking	
Е	Jan.19,2011			Updated Dimensions drawing	
F	Jun.7,2011			Updated Dimensions drawing	
G	Mar.10,2014		_	Updated Dimensions drawing	

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ELECTRICAL SPECIFICATIONS

SRe Part Number: G53270004

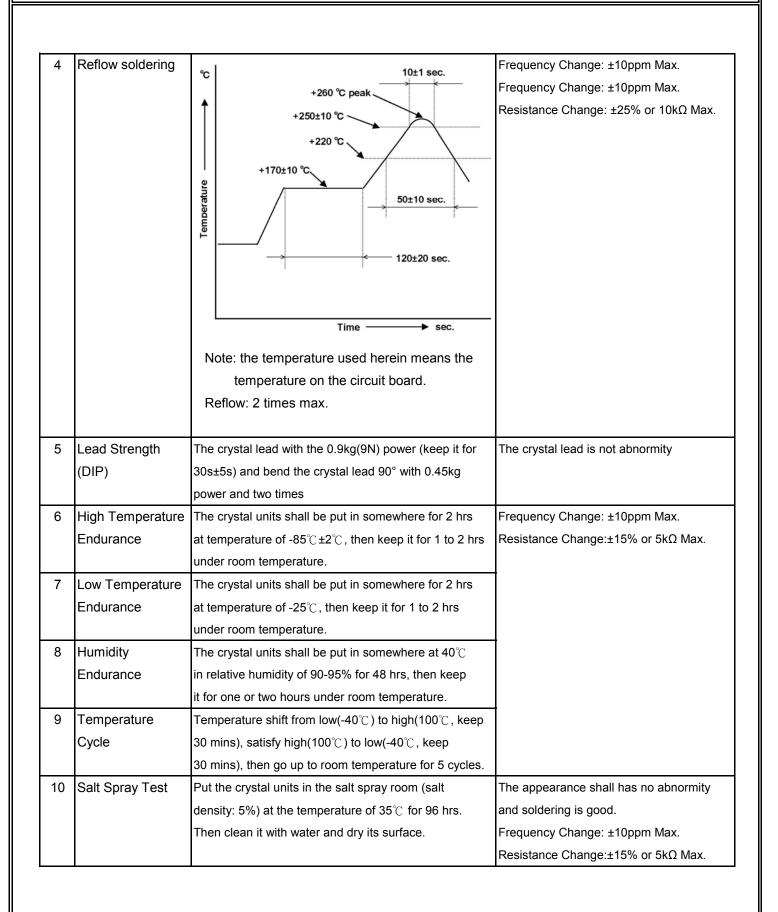
Parameters	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	32.768	KHz	
Frequency Tolerance	FT	± 20	ppm	at 25°C ± 5°C
Load Capacitance	CL	12.5	pF	Тур.
Drive Level	DL	1	μW	Max.
Equivalent Series Resistance	ESR	65	ΚΩ	Max.
Temperature Coefficient	K	-0.035	ppm/°C	Тур.
Operating Temperature Range	TR	-40~85	°C	
Storage Temperature Range		-55~85	°C	
Aging		± 3	ppm	Max 1st year
Insulation Resistance		500	ΜΩ	Min.

Reliability (Mechanical and Environmental Endurance)

No.	Test Items	Test Method and Condition Requirements		
1	Vibration	(1) Vibration Frequency: 10 to 55Hz	Frequency Change: ±10ppm Max.	
		(2) Vibration Amplitude: 1.5mm	Resistance Change: $\pm 15\%$ or $5k\Omega$ Max.	
		(3) Cycle Time: 1-2min(10-55-10Hz)		
		(4) Direction: X.Y.Z		
		(5) Duration: 2h/each direction		
2	Shock	3 Times free drop from 75cm height to hard wooden	Frequency Change: ±10ppm Max.	
		board of thickness more than 30mm	Resistance Change: ±15% or 5kΩ Max.	
3	Leakage	Put crystal units into a hermetic container and	Leakage: 1x10 ⁻ 8Pa·m3/s Max.	
		Helium for 0.5-0.6Mpa, and keep it for 1h;		
		Check the leakage by a Helium leak detector		

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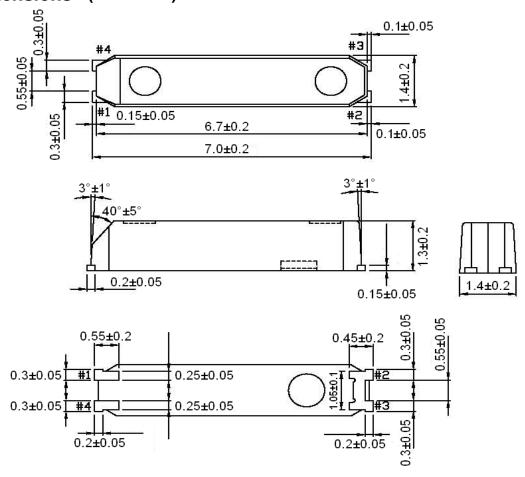
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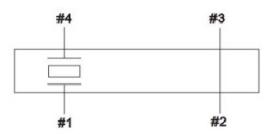
Marking



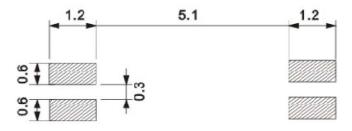
Dimensions (Units: mm)



Internal Lead Connection



Recommended Soldering Pattent(unit: mm)



Note:

- 1. Do not connect #2 and #3 to external device and GND.
- 2. The part of the cylinder inside resin mold may be sometimes exposed, however, it does not affect the characteristics of crystal unit.
- 3. Please make sure that there is no pattern under TMXLF-130 on the circuit board.

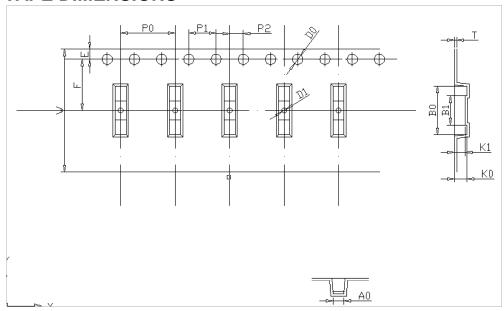
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TAPE AND REEL SPECIFICATION

- 1. Tape and Reel form conform to EIA-481-B.
- 2. The quantity of crystal units per reel shall be 3000PCS.
- 3. A "LABEL" on which necessary information is clearly written is on the surface of packing box and the reel.

CARRIER TAPE DIMENSIONS



W	E	F	D0	D1	P0	P1	P2
16.00±0.30	1.75±0.1	7.50±0.1	1.5 ^{+0.1} -0	1.0 ^{+0.1} 1.0 -0	8.00±0.1	4.00±0.1	2.00±0.05
A0	В0	B1	K0	K1	T	10*P ₀	
1.70±0.1	7.20±0.1	4.0±0.1	1.7±0.1	1.25±0.1	0.35±0.05	40.00±0.20	

REEL DIMENSIONS

